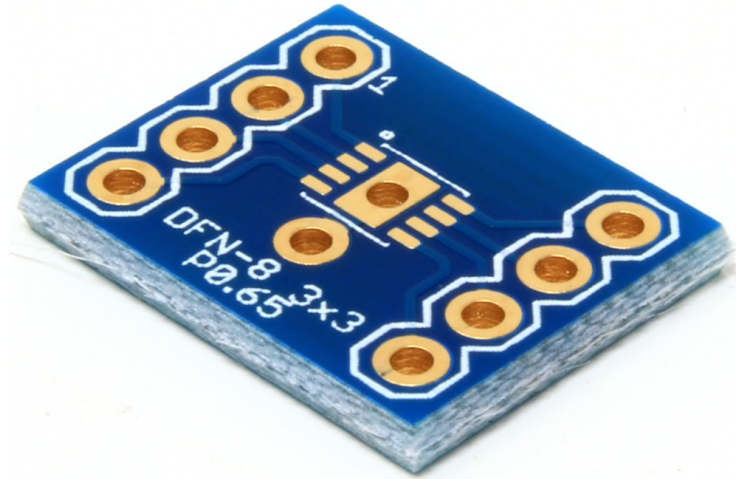


DA-DFN8-3X3P65

DFN-8 TO DIP ADAPTER – 3mm x 3mm – P0.65



This adapter breaks out the pins of a DFN-8 component (with a body of 3mm x 3mm and 0.65mm pin pitch) into a board with 0.1" (2.54mm) spaced pins.

This is a high quality PCB, with all the copper pads and contacts plated with Electroless Nickel Immersion Gold (ENIG) process, offering an excellent surface planarity and oxidation resistance.

The land pattern includes a central pad that can be used to dissipate heat from a high-power integrated circuit, like a motor controller or an audio amplifier. There is also a hole drilled through the central pad that can be used to drop some solder and ensure dissipation and conductivity up to the component. The central pad is connected to a dedicated outer pad allowing to eventually wire a connection to it.

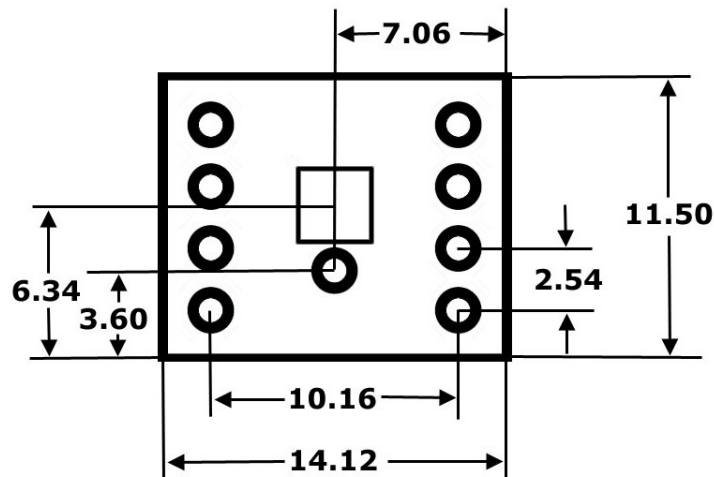
Specifications

Supported packages	DFN-8
Package body size	3mm x 3mm
Component pin pitch	0.65mm
Board pin pitch	2.54mm (0.1")
Temperature rating	-25°C to +125°C
Material	FR4
RoHS compliant	Yes

Board dimensions

All dimensions are in millimeters

DFN-8
Body: 3x3
Pitch: 0.65



Land pattern dimensions

All dimensions are in millimeters

DFN-8
Body: 3x3
Pitch: 0.65

